

2SK615

Silicon N-Channel MOS

For switching

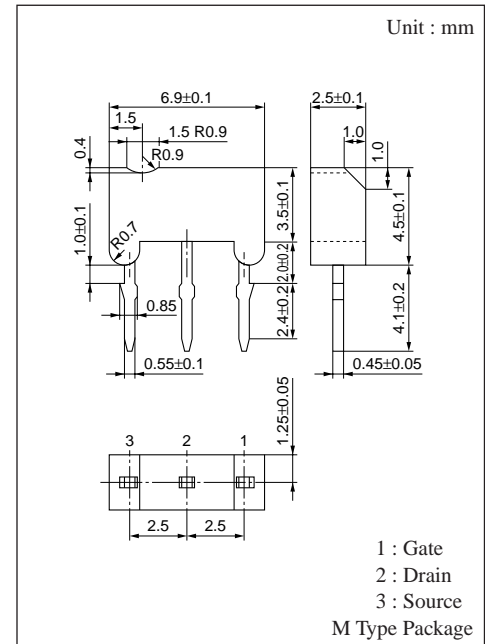
■ Features

- Low ON-resistance $R_{DS(on)}$
- High-speed switching
- Direct drive possible with CMOS, TTL
- Easy automatic- /manual-insertion due to M type package. Self-fixing to printed circuits board.

■ Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Rating	Unit
Drain-Source voltage	V_{DS}	80	V
Gate-Source voltage	V_{GS}	20	V
Drain current	I_D	± 0.5	A
Max drain current	I_{DP}	± 1	A
Allowable power dissipation	P_D^*	1	W
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	- 55 to +150	$^\circ\text{C}$

* PC board : Copper foil area of drain portion should be 1cm^2 or more, thickness 1.7mm.

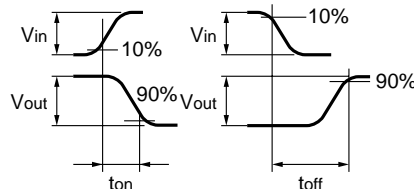
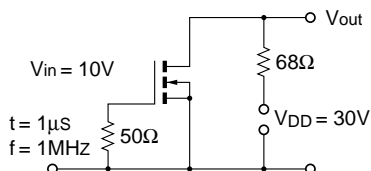


■ Electrical Characteristics ($T_a = 25^\circ\text{C}$)

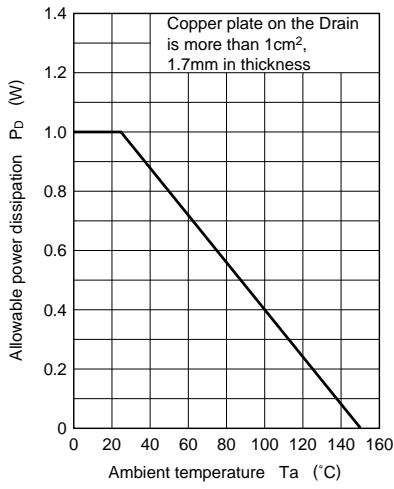
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Drain-Source cut-off current	I_{DSS}	$V_{DS}=60\text{V}, V_{GS}=0$			10	μA
Gate-Source leakage current	I_{GSS}	$V_{GS}=20\text{V}, V_{DS}=0$			0.1	μA
Drain-Source breakdown voltage	V_{DSS}	$I_D=100\mu\text{A}, V_{GS}=0$	80			V
Gate threshold voltage	V_{th}	$I_D=1\text{mA}, V_{DS}=V_{GS}$	1.5		3.5	V
Drain-Source ON-resistance	$R_{DS(on)}^{*1}$	$I_D=0.5\text{A}, V_{GS}=10\text{V}$		2	4	Ω
Forward transadmittance	$ Y_{fs} $	$I_D=0.2\text{A}, V_{DS}=15\text{V}, f=1\text{kHz}$		300		mS
Input capacitance	C_{iss}	$V_{DS}=10\text{V}, V_{GS}=0, f=1\text{MHz}$		45		pF
Output capacitance	C_{oss}			30		pF
Feedback capacitance	C_{rss}			8		pF
Turn-on time	t_{on}^{*1*2}			15		ns
Turn-off time	t_{off}^{*1*2}			20		ns

* 1 Pulse measurement

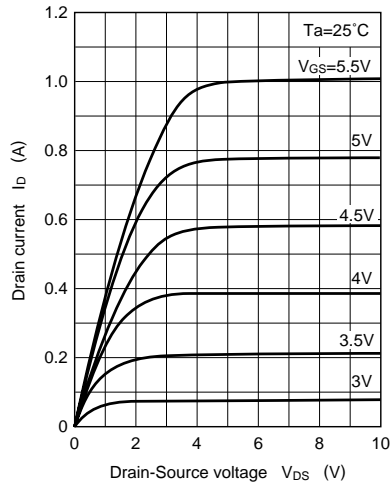
* 2 t_{on}, t_{off} measurement circuit



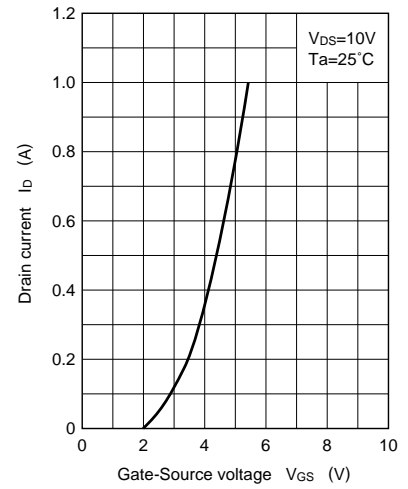
$P_D - T_a$



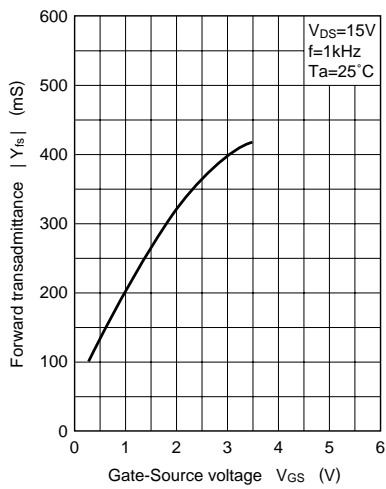
$I_D - V_{DS}$



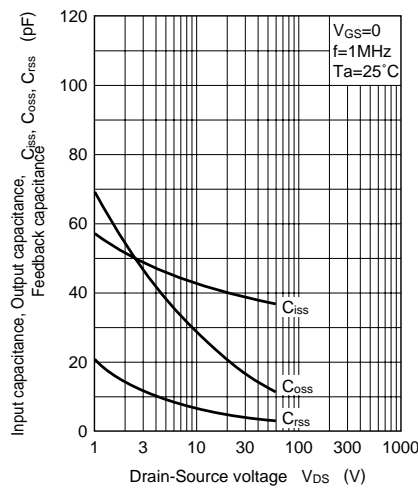
$I_D - V_{GS}$



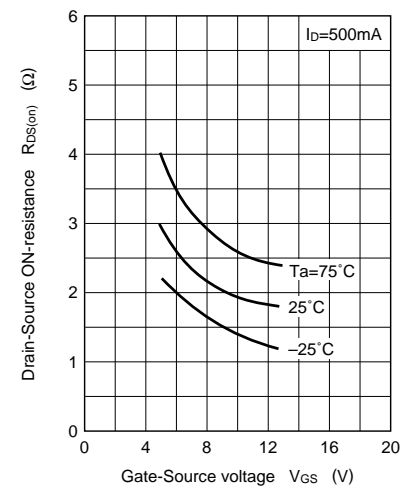
$|Y_{fs}| - V_{GS}$



$C_{iss}, C_{oss}, C_{rss} - V_{DS}$



$R_{DS(on)} - V_{GS}$



$R_{DS(on)} - T_a$

